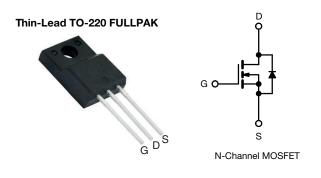
## SiHA12N50E

**Vishay Siliconix** 



### **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	550				
R <sub>DS(on)</sub> max. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.380				
Q <sub>g</sub> max. (nC)	50				
Q <sub>gs</sub> (nC)	6				
Q <sub>gd</sub> (nC)	10				
Configuration	Single				

#### FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Low gate charge (Q<sub>a</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Computing
  - PC silver box / ATX power supplies
- Lighting
  - Two stage LED lighting
- Consumer electronics
- Applications using hard switched topologies
  - Power factor correction (PFC)
  - Two switch forward converter
  - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free	SiHA12N50E-E3			
Lead (Pb)-free and halogen-free	SiHA12N50E-GE3			

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	500	N	
Gate-source voltage			V <sub>GS</sub>	± 30	- V	
Continuous drain surrant (T 150 °C) f	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$		10.5		
Continuous drain current ( $T_J = 150 \ ^\circ C$ ) $^e$	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	6.6	A	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	21	1	
Linear derating factor				0.91	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	103	mJ	
Maximum power dissipation			P <sub>D</sub>	32	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	$V_{DS} = 0 V t$	to 80 % V <sub>DS</sub>	d\//dt	70		
Reverse diode dV/dt <sup>d</sup>			dV/dt	27	V/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	for 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,\,I_{AS}$  = 2.7 A
- c. 1.6 mm from case
- d.  $I_{SD} \leq I_D$ , dI/dt = 100 A/µs, starting  $T_J$  = 25 °C
- e. Limited by maximum junction temperature

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-	- 65					
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 3.9			°C/W			
	•	•						
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ , $\iota$	inless otherwi	se noted)						
PARAMETER	SYMBOL			ONS	MIN.	TYP.	MAX.	UNI
Static				-				<u> </u>
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		50 µA	500	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C, Ir		-	0.60	-	V/°(
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	- 50 μΑ	2.0	-	4.0	V
	00(0)		$V_{GS} = \pm 20$ V		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30$ V		-	-	± 1	μA
			= 500 V, V <sub>GS</sub>		-	-	1	<u> </u>
Zero gate voltage drain current	I <sub>DSS</sub>		$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		= 6 A	-	0.330	0.380	Ω
Forward transconductance	<b>g</b> <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> =	6 A	-	3.1	-	S
Dynamic						ļ	ļ	
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	886	-		
Output capacitance	C <sub>oss</sub>			-	52	-		
Reverse transfer capacitance	C <sub>rss</sub>			-	6	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V		-	45	-	pF	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	131	-	1	
Total gate charge	Qg			-	25	50		
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	$V_{GS} = 10 V$ $I_D = 6 A, V_{DS} = 400 V$		-	6	-	nC
Gate-drain charge	Q <sub>gd</sub>				-	10	-	1
Turn-on delay time	t <sub>d(on)</sub>				-	13	26	
Rise time	t <sub>r</sub>	$V_{DD} = 400 \text{ V}, \text{ I}_D = 6 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_g = 9.1 \Omega$ f = 1 MHz, open drain		-	16	32		
Turn-off delay time	t <sub>d(off)</sub>			-	29	58	- ns	
Fall time	t <sub>f</sub>			-	12	24		
Gate input resistance	Rg			-	0.92	-	Ω	
Drain-Source Body Diode Characteristic	cs							
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10.5	A	
Pulsed diode forward current	I <sub>SM</sub>			-	-	21		
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 7.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V	
Reverse recovery time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 6 \text{ A},$ dl/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	244	-	ns	
Reverse recovery charge	Q <sub>rr</sub>			-	2.5	-	μ	
Reverse recovery current	I <sub>RRM</sub>			-	19	-	A	

Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

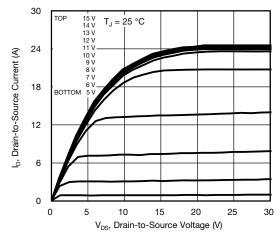
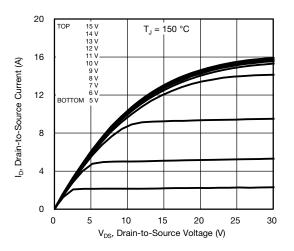


Fig. 1 - Typical Output Characteristics





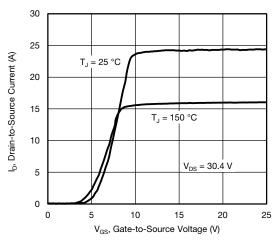


Fig. 3 - Typical Transfer Characteristics

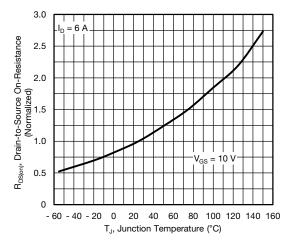


Fig. 4 - Normalized On-Resistance vs. Temperature

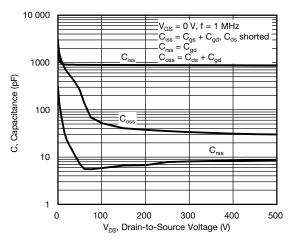


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

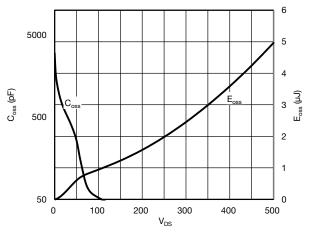


Fig. 6 -  $C_{\text{oss}}$  and  $E_{\text{oss}}$  vs.  $V_{\text{DS}}$ 

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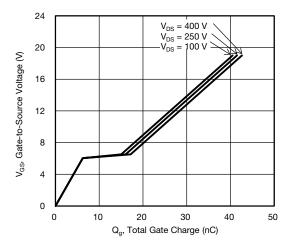


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

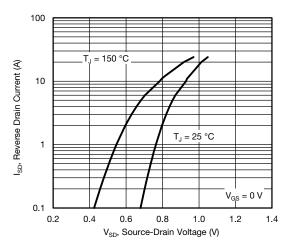


Fig. 8 - Typical Source-Drain Diode Forward Voltage

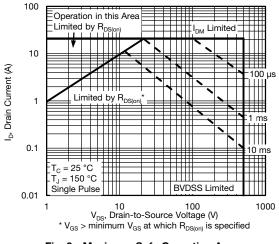


Fig. 9 - Maximum Safe Operating Area

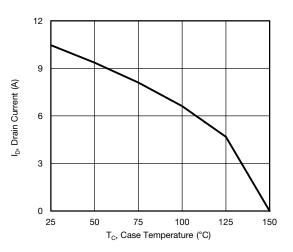


Fig. 10 - Maximum Drain Current vs. Case Temperature

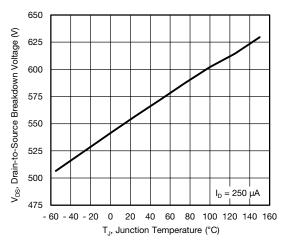
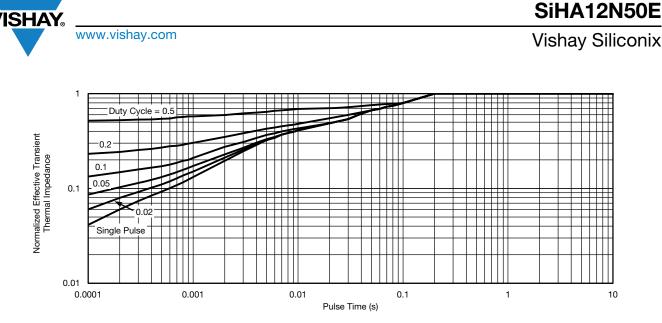


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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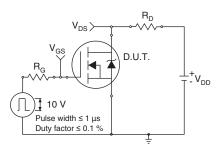


Fig. 13 - Switching Time Test Circuit

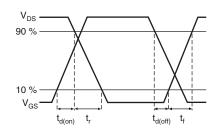


Fig. 14 - Switching Time Waveforms

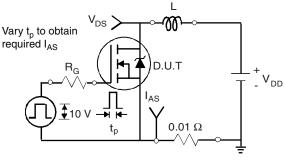


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

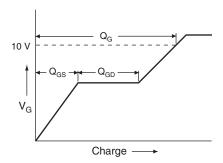


Fig. 17 - Basic Gate Charge Waveform

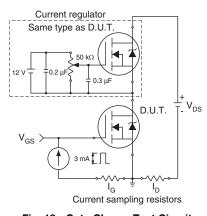


Fig. 18 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit

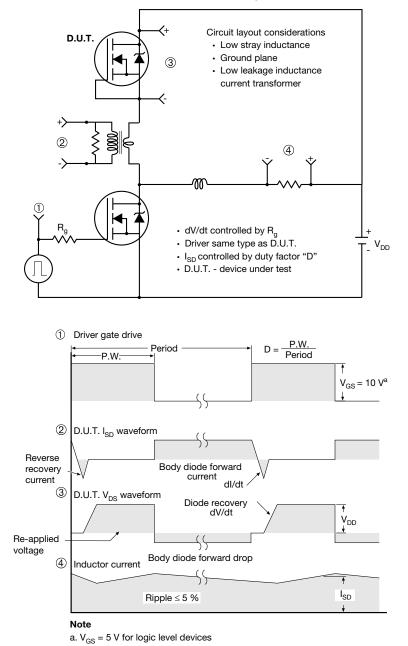


Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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